

IP9266K

Dielectric / Glaze

Description

IP9266K is a thin print overglaze that fires to a clear, thin, dense film at 720°C. IP9266K fires at a wide range of temperatures.

Key Features

- Clear, hermetic film Wide processing window
Compatible with Au organometallic fired films



This picture does not show the packaging of IP9266K and is solely intended for illustration purposes. The products are available in different packaging configurations and may change over time. Please refer to the latest safety data sheets for safety-relevant pictograms.

Typical Properties

Viscosity	10 – 20 Kcps Brookfield RVTSC4 – 14 spindle, 6R utility cup at 10 rpm, 25 °C
Solids	50 ± 1 %
Blendable	
Coverage	
Color	White

Recommended Processing Guide

Printing Parameters	400 stainless steel mesh screen 0.5 mil emulsion 1.0 mil wire
Printing Speed	
Leveling	
Drying Temperature	150 °C for 10 minutes
Process Temperature (TDS)	720 °C peak temperature Dwell time of 4 – 6 minutes at peak
Film Thickness	3 – 5 µm
Recommended Thinner	RV-372
Paste Compatibility	

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Warranty

2 months

Storage

store in a dry, cool (5 – 25 °C) and dark place with container tightly shut

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